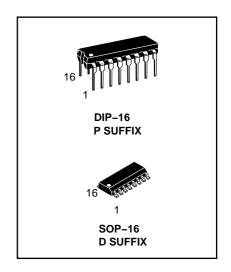


# **High Voltage, High Current Darlington Transistor Arrays**

The seven NPN Darlington connected transistors in these arrays are well suited for driving lamps, relays, or printer hammers in a variety of industrial and consumer applications. Their high breakdown voltage and internal suppression diodes insure freedom from problems associated with inductive loads. Peak inrush currents to 500 mA permit them to drive incandescent lamps.

The MC1413, B with a 2.7 k $\Omega$  series input resistor is well suited for systems utilizing a 5.0 V TTL or CMOS Logic.



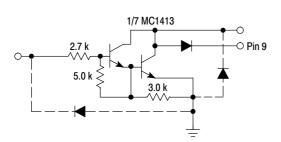


Figure 1. Representative Schematic Diagram

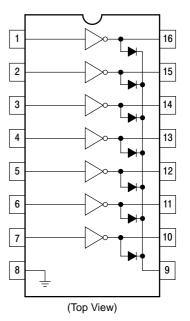


Figure 2. PIN CONNECTIONS



### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ , and rating apply to any one device in the package, unless otherwise noted.)

Rating	Symbol	Value	Unit
Output Voltage	Vo	50	V
Input Voltage	V <sub>I</sub>	30	V
Collector Current – Continuous	I <sub>C</sub>	500	mA
Base Current – Continuous	I <sub>B</sub>	25	mA
Operating Ambient Temperature Range MC1413 MC1413B	T <sub>A</sub>	-20 to +85 -40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Junction Temperature	TJ	150	°C
Thermal Resistance, Junction-to-Ambient P Suffix D Suffix	$R_{ heta JA}$	67 100	°C/W
Thermal Resistance, Junction-to-Case P Suffix D Suffix	$R_{ heta JC}$	22 20	°C/W
Electrostatic Discharge Sensitivity (ESD) Human Body Model (HBM) Machine Model (MM) Charged Device Model (CDM)	ESD	2000 400 1500	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

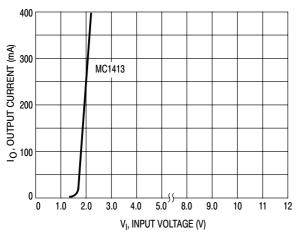


## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ , unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Output Leakage Current $(V_O = 50 \text{ V}, T_A = +85^{\circ}\text{C})$ $(V_O = 50 \text{ V}, T_A = +25^{\circ}\text{C})$	I <sub>CEX</sub>	- -	- -	100 50	μΑ
Collector–Emitter Saturation Voltage ( $I_C$ = 350 mA, $I_B$ = 500 $\mu$ A) ( $I_C$ = 200 mA, $I_B$ = 350 $\mu$ A) ( $I_C$ = 100 mA, $I_B$ = 250 $\mu$ A)	V <sub>CE(sat)</sub>	- - -	1.1 0.95 0.85	1.6 1.3 1.1	V
Input Current – On Condition (V <sub>I</sub> = 3.85 V)	I <sub>I(on)</sub>	_	0.93	1.35	mA
Input Voltage – On Condition $(V_{CE} = 2.0 \text{ V}, I_{C} = 200 \text{ mA})$ $(V_{CE} = 2.0 \text{ V}, I_{C} = 250 \text{ mA})$ $(V_{CE} = 2.0 \text{ V}, I_{C} = 300 \text{ mA})$	V <sub>I(on)</sub>	- - -	- - -	2.4 2.7 3.0	V
Input Current – Off Condition (I <sub>C</sub> = 500 $\mu$ A, T <sub>A</sub> = 85°C)	I <sub>I(off)</sub>	50	100	-	μΑ
DC Current Gain $(V_{CE} = 2.0 \text{ V}, I_{C} = 350 \text{ mA})$	h <sub>FE</sub>	1000	-	-	-
Input Capacitance	C <sub>I</sub>	_	15	30	pF
Turn-On Delay Time (50% E <sub>I</sub> to 50% E <sub>O</sub> )	t <sub>on</sub>	-	0.25	1.0	μS
Turn-Off Delay Time (50% E <sub>I</sub> to 50% E <sub>O</sub> )	t <sub>off</sub>	-	0.25	1.0	μS
Clamp Diode Leakage Current $T_A = +25^{\circ}C$ $(V_R = 50 \text{ V})$ $T_A = +85^{\circ}C$	I <sub>R</sub>	- -	-	50 100	μΑ
Clamp Diode Forward Voltage (I <sub>F</sub> = 350 mA)	V <sub>F</sub>	-	1.5	2.0	V



### TYPICAL PERFORMANCE CURVES – $T_A = 25$ °C



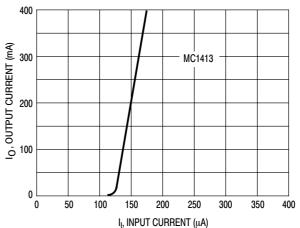
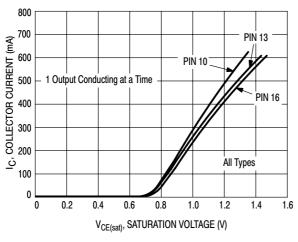


Figure 3. Output Current versus Input Voltage

Figure 4. Output Current versus Input Current



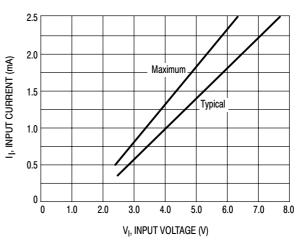


Figure 5. Typical Output Characteristics

Figure 6. Input Characteristics

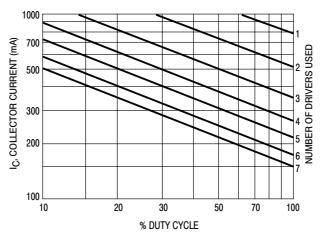


Figure 7. Maximum Collector Current versus Duty Cycle (and Number of Drivers in Use)



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